

## Halar® 500LC

# ethylene chlorotrifluoroethylene copolymer

General			
Material Status	<ul> <li>Commercial: Active</li> </ul>		
Availability	<ul><li>Africa &amp; Middle East</li><li>Asia Pacific</li><li>Europe</li></ul>	<ul><li>Latin America</li><li>North America</li></ul>	
Features	<ul> <li>Low Viscosity</li> </ul>		
Forms	<ul> <li>Pellets</li> </ul>		
Processing Method	<ul> <li>Extrusion</li> </ul>	<ul> <li>Injection Molding</li> </ul>	
Physical		Typical Value Unit	Test method
Density / Specific Gravity		1.68	ASTM D792
Melt Mass-Flow Rate (MFR) (	275°C/216 kg)	18 g/10 min	ASTM D1238
Molding Shrinkage - Flow	270 072.10 kg/	2.5 %	ASTM D955
Water Absorption (Equilibrium	m)	< 0.10 %	ASTM D570
Water Absorption (Equilibria)	,	3 0.10 70	ACTIVI DOTO
Mechanical		Typical Value Unit	Test method
Tensile Modulus¹ (23°C)		1660 MPa	ASTM D638
Tensile Strength <sup>1</sup>			ASTM D638
Yield, 23°C		30.0 MPa	
Break, 23°C		47.0 MPa	
Tensile Elongation <sup>1</sup>			ASTM D638
Yield, 23°C		5.0 %	
Break, 23°C		250 %	
Flexural Modulus <sup>2</sup> (23°C)		1690 MPa	ASTM D790
Flexural Strength <sup>2</sup> (23°C)		47.0 MPa	ASTM D790
Coefficient of Friction			ASTM D1894
vs. Itself - Dynamic		0.20	
vs. Itself - Static		0.20	
Impact		Typical Value Unit	Test method
Notched Izod Impact		50 J/m	ASTM D256
-40°C, 3.20 mm		•	
23°C, 3.20 mm		No Break	
Hardness		Typical Value Unit	Test method
Rockwell Hardness (R-Scale)		90	ASTM D785
Durometer Hardness (Shore D)		75	ASTM D2240

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Thermal	Typical Value U	Jnit	Test method
Deflection Temperature Under Load			ASTM D648
0.45 MPa, Unannealed	90.0 °0	С	
1.8 MPa, Unannealed	65.0 °C	С	
Brittleness Temperature	< -76.0 °C	С	ASTM D746A
Glass Transition Temperature	85.0 °C	С	DMA
Melting Temperature	242 °C	С	ASTM D3418
Peak Crystallization Temperature (DSC)	222 °C	С	ASTM D3418
CLTE - Flow	1.0E-4 c	:m/cm/°C	ASTM D696
Specific Heat (23°C)	962 J,	/kg/°C	ASTM D3418
Thermal Conductivity (40°C)	0.15 W	V/m/K	ASTM C177
Crystallization Heat	40.0 J	/g	ASTM D3418
Heat of Fusion	42.0 J	/g	ASTM D3418
Thermal Stability - 1% mass loss, N2	405 °C	С	TGA
Electrical	Typical Value U	Init	Test method
Volume Resistivity 3 (23°C)	5.5E+16 o	hms∙cm	ASTM D257
Dielectric Strength (23°C, 3.20 mm)	14 k'	v/mm	ASTM D149
Dielectric Constant (23°C, 1 MHz)	2.57		ASTM D150
Flammability	Typical Value U	Init	Test method
Flame Rating	V-0		UL 94
Oxygen Index	52 %	0	ASTM D2863

#### Additional Information

#### Storage and Handling

 Halar® melt processable fluoropolymer resins can be stored without shelf life issues when kept in a clean and dry area at ambient temperatures. Opened containers should be tightly resealed to prevent any contamination.

### **Notes**

Typical properties: these are not to be construed as specifications.

- <sup>1</sup> 50 mm/min
- <sup>2</sup> 2.5 mm/min
- <sup>3</sup> 50% RH

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